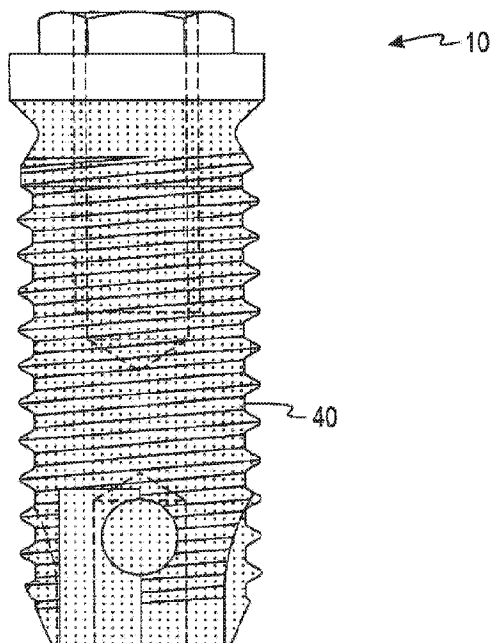




(86) Date de dépôt PCT/PCT Filing Date: 2016/08/10
(87) Date publication PCT/PCT Publication Date: 2017/02/16
(45) Date de délivrance/Issue Date: 2021/10/19
(85) Entrée phase nationale/National Entry: 2018/01/30
(86) N° demande PCT/PCT Application No.: US 2016/046354
(87) N° publication PCT/PCT Publication No.: 2017/027593
(30) Priorité/Priority: 2015/08/11 (US62/203,733)

(51) Cl.Int./Int.Cl. *A61C 8/00* (2006.01)
(72) Inventeurs/Inventors:
MANDANICI, DANIEL, US;
SUTTIN, ZACHARY B., US;
LIN, KENG-MIN, US;
SANCHEZ, OLGA, US
(73) Propriétaire/Owner:
BIOMET 3I, LLC, US
(74) Agent: NORTON ROSE FULBRIGHT CANADA
LLP/S.E.N.C.R.L., S.R.L.

(54) Titre : TRAITEMENT DE SURFACE POUR SURFACE D'IMPLANT
(54) Title: SURFACE TREATMENT FOR AN IMPLANT SURFACE



(57) Abrégé/Abstract:

A method of forming an implant to be implanted into living bone. The implant includes titanium. The method includes deforming at least a portion of a surface of the implant to produce a first micro-scale topography. The method further includes removing at least a portion of the surface to produce a second micro-scale topography superimposed on the first topography. The second micro-scale topography is generally less coarse than the first micro-scale topography. The method further includes adding a submicron topography superimposed on the first and second micro-scale topographies, the submicron topography including tube-like structures.

(12) INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(19) World Intellectual Property
Organization
International Bureau



(10) International Publication Number
WO 2017/027593 A1

(43) International Publication Date
16 February 2017 (16.02.2017)

- (51) International Patent Classification:
A61C 8/00 (2006.01)
- (21) International Application Number:
PCT/US2016/046354
- (22) International Filing Date:
10 August 2016 (10.08.2016)
- (25) Filing Language: English
- (26) Publication Language: English
- (30) Priority Data:
62/203,733 11 August 2015 (11.08.2015) US
- (71) Applicant: **BIOMET 3I, LLC** [US/US]; 4555 Riverside Drive, Palm Beach Gardens, FL 33410 (US).
- (72) Inventors: **MANDANICI, Daniel**; 16785-90th Street North, Loxahatchee, FL 33470 (US). **SUTTIN, Zachary, B.**; 10436 Orchid Reserve Drive, West Palm Beach, FL 33412 (US). **LIN, Keng-Min**; 143 Sylvan Avenue, San Mateo, CA 94403 (US). **SANCHEZ, Olga**; 11968 Suellen Circle, Wellington, FL 33414 (US).
- (74) Agents: **ARORA, Suneel** et al.; Schwegman, Lundberg & Woessner, P.A., P.O. Box 2938, Minneapolis, MN 55402 (US).
- (81) Designated States (*unless otherwise indicated, for every kind of national protection available*): AE, AG, AL, AM, AO, AT, AU, AZ, BA, BB, BG, BH, BN, BR, BW, BY, BZ, CA, CH, CL, CN, CO, CR, CU, CZ, DE, DK, DM, DO, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, GT, HN, HR, HU, ID, IL, IN, IR, IS, JP, KE, KG, KN, KP, KR, KZ, LA, LC, LK, LR, LS, LU, LY, MA, MD, ME, MG, MK, MN, MW, MX, MY, MZ, NA, NG, NI, NO, NZ, OM, PA, PE, PG, PH, PL, PT, QA, RO, RS, RU, RW, SA, SC, SD, SE, SG, SK, SL, SM, ST, SV, SY, TH, TJ, TM, TN, TR, TT, TZ, UA, UG, US, UZ, VC, VN, ZA, ZM, ZW.
- (84) Designated States (*unless otherwise indicated, for every kind of regional protection available*): ARIPO (BW, GH, GM, KE, LR, LS, MW, MZ, NA, RW, SD, SL, ST, SZ, TZ, UG, ZM, ZW), Eurasian (AM, AZ, BY, KG, KZ, RU, TJ, TM), European (AL, AT, BE, BG, CH, CY, CZ, DE, DK, EE, ES, FI, FR, GB, GR, HR, HU, IE, IS, IT, LT, LU, LV, MC, MK, MT, NL, NO, PL, PT, RO, RS, SE, SI, SK,

[Continued on next page]

(54) Title: SURFACE TREATMENT FOR AN IMPLANT SURFACE

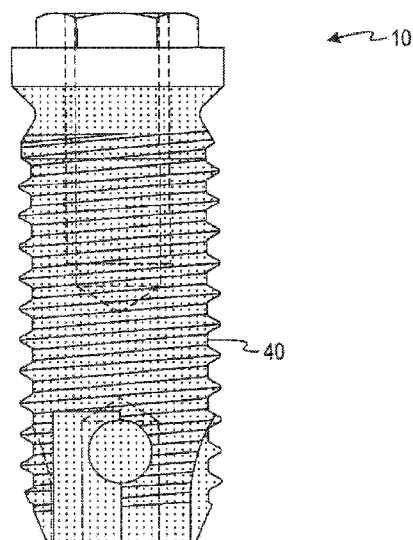


Fig. 6

(57) Abstract: A method of forming an implant to be implanted into living bone. The implant includes titanium. The method includes deforming at least a portion of a surface of the implant to produce a first micro-scale topography. The method further includes removing at least a portion of the surface to produce a second micro-scale topography superimposed on the first topography. The second micro-scale topography is generally less coarse than the first micro-scale topography. The method further includes adding a sub-micron topography superimposed on the first and second micro-scale topographies, the submicron topography including tube-like structures.

WO 2017/027593 A1



SM, TR), OAPI (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, —
GW, KM, ML, MR, NE, SN, TD, TG).

*before the expiration of the time limit for amending the
claims and to be republished in the event of receipt of
amendments (Rule 48.2(h))*

Published:

— *with international search report (Art. 21(3))*

SURFACE TREATMENT FOR AN IMPLANT SURFACE

CLAIM OF PRIORITY

5 **[0001]** This application claims the benefit of U.S. Provisional Patent Application Serial No. 62/203,733, filed on August 11, 2015, the benefit of priority of which is claimed hereby.

FIELD OF THE INVENTION

10 **[0002]** This invention relates generally to implants and, in particular, to dental implants having a layer of topographical complexities in the coarse-micron, fine-micron, and submicron ranges, respectively.

BACKGROUND OF THE INVENTION

15 **[0003]** It is becoming more common to replace a missing tooth with a prosthetic tooth that is placed upon and attached to a dental implant. Dental implants are often comprised of metal and metal alloys, including titanium (Ti) and titanium alloys. The dental implant serves as an artificial root that integrates with the gingiva and the bone tissue of the mouth.

20 **[0004]** For the dental implant to function successfully, sufficient osseointegration is required. In other words, a bond between the implant and the bone must be formed and retained. The surface of the implant may be roughened to help enhance the osseointegration process. Non-limiting examples of processes for roughening an implant surface include acid etching and grit blasting, which impart roughness on the surface.

25 **[0005]** Other existing techniques involve forming a generally thin (e.g., generally less than 10 microns) coating of osseointegration materials, such as hydroxy apatite (HA), other calcium phosphates, or other osseointegration compounds for forming a direct chemical compound between the implant and the bone. Plasma spraying and sputtering are two major techniques that have been used
30 to deposit, for example, HA, onto an implant surface.

[0006] U.S. Patent Application Publication Nos. 2008/0220394, 2007/0110890, and 2007/0112353 disclose methods of discrete deposition of hydroxyapatite crystals to impart a nano-scale topography. Although effective, the disclosed processes require that a residual substance (i.e., HA crystals) be left on the surface post-processing to impart a nano-scale topography into the surface.

[0007] The present invention is directed to an improved implant having a submicron topography superimposed on dual micron topographies for improving the rate and extent of osseointegration and methods of making the same.

10 SUMMARY OF THE INVENTION

[0008] In one process described herein, a method of forming an implant to be implanted into living bone is disclosed. The implant is formed of a material comprising titanium. The method includes deforming at least a portion of a surface of the implant to produce a first micro-scale topography. The method further includes removing at least a portion of the surface to produce a second micro-scale topography superimposed on the first topography. The second micro-scale topography is generally less coarse than the first micro-scale topography. The method further includes adding a submicron topography superimposed on the first and second micro-scale topographies, the submicron topography including tube-like structures.

[0009] In another process, another method of forming an implant to be implanted into living bone is disclosed. The method includes grit blasting at least the portion of a surface of the implant to produce a first roughened surface including peak-to-valley heights of about 10 microns to about 30 microns. The method further includes acid etching the grit blasted surface to produce a second roughened surface having peak-to-valley heights of less than about 10 microns superimposed on the first roughened surface. The method further includes providing a submicron topography superimposed on the second roughened surface, the submicron topography including nanoscale tube-like structures.

[0010] In one embodiment, an implant to be implanted into living bone is disclosed. The implant is formed of a material comprising titanium. The implant

includes a first micro-scale topography. The implant further includes a second micro-scale topography superimposed on the first topography. The second micro-scale topography is generally less coarse than the first micro-scale topography. The implant further includes a submicron topography superimposed on the first and second micro-scale topographies. The submicron topography includes tube-like structures.

[0011] The above summary of the present invention is not intended to represent each embodiment, or every aspect, of the present invention. This is the purpose of the figures and the detailed description which follow.

10

BRIEF DESCRIPTION OF THE DRAWINGS

- [0012] The foregoing and other advantages of the invention will become apparent upon reading the following detailed description and upon reference to the drawings.
- 15 [0013] FIG. 1 is a side view of an implant according to one embodiment.
- [0014] FIG. 2a is a side view of an implant according to a second embodiment.
- [0015] FIG. 2b is an insertion end view of the implant of FIG. 2a.
- [0016] FIG. 2c is a gingival end view of the implant of FIGs. 2a, 2b.
- 20 [0017] FIG. 3a is a side view of an implant according to a third embodiment.
- [0018] FIG. 3b is an insertion end view of the implant of FIG. 3a.
- [0019] FIG. 3c is a gingival end view of the implant of FIGs. 3a, 3b.
- [0020] FIG. 4a is a side view of an implant according to a fourth embodiment.
- 25 [0021] FIG. 4b is an end view of the implant of FIG. 4a.
- [0022] FIG. 5 is a flow diagram detailing a method of forming an implant according to an embodiment.
- [0023] FIG. 6 is a side view of the implant in FIG. 1 with a roughened outer surface.
- 30 [0024] FIG. 7 is a flow diagram detailing a method of forming an implant according to another embodiment.

[0025] FIG. 8a is a Field Emission Scanning Electron microscopy (FESEM) image showing a commercially pure titanium having a coarse-micron topography, fine-micron topography, and submicron topography at 5kX.

[0026] FIG. 8b is an FESEM image showing the implant of FIG. 8a at 10kX.

5 [0027] FIG. 8c is an FESEM image showing the implant of FIGs. 8a, 8b at 30kX.

[0028] While the invention is susceptible to various modifications and alternative forms, specific embodiments have been shown by way of example in the drawings and will be described in detail herein. It should be understood, however,
10 that the invention is not intended to be limited to the particular forms disclosed. Rather, the invention is to cover all modifications, equivalents, and alternatives falling within the spirit and scope of the invention as defined by the appended claims.

15 DETAILED DESCRIPTION OF THE INVENTION

[0029] The embodiments discussed herein are directed to implants having various layers of topographical surface complexities at distinct and varied scale ranges and methods of making the same. Specifically, the implants discussed herein include topographical complexities in the coarse-micron, micron, and submicron
20 scale ranges.

[0030] An implant in the context of the present invention means a device intended to be placed within a human body, such as to connect skeletal structures (e.g., a hip implant) or to serve as a fixture for a body part (e.g., a fixture for an artificial tooth). Although the remainder of this application is directed to dental
25 implants, it is contemplated that the embodiments discussed herein may also be applied to other (e.g., medical) implants.

[0031] FIG. 1 shows a standard dental implant 10 that includes a head portion 12, a lowermost end 14, and a threaded bottom portion 16. The implant 10 may, for example, be made of titanium, tantalum, cobalt, chromium, stainless steel,
30 or alloys thereof. FIGs. 2a-c, 3a-c, and 4a-b, which are discussed below, describe alternative implant designs that may also be used with the present invention.

[0032] In the implant 10 of FIG. 1, the head portion 12 includes a non-rotational feature. In the embodiment shown, the non-rotational feature includes a polygonal boss 20 that may be engageable with a tool that screws the implant 10 into bone tissue. In the illustrated embodiment, the polygonal boss 20 is hexagonal. The polygonal boss 20 may also be used for non-rotationally engaging a correspondingly shaped socket on a restorative or prosthetic component that is attached to the implant 10.

[0033] The exterior of the threaded bottom portion 16 facilitates bonding with bone or gingiva. The threaded bottom section 16 includes a thread 18 that makes a plurality of turns around the implant 10. The threaded bottom portion 16 may further include a self-tapping region with incremental cutting edges 17 that allows the implant 10 to be installed without the need for a bone tap. These incremental cutting edges 17 are described in detail in U.S. Patent No. 5,727,943, titled "Self-Tapping, Screw- Type Dental Implant".

[0034] FIGs. 2a-c disclose an implant 36 that differs from the implant 10 of FIG. 1 in the details of the cutting edges 17' and the contours of the threads defining the exterior of the threaded bottom portion 16'. When viewed in the cross-section (see FIG. 1b), the threaded outer surface 16' is non-circular in the region of the threads and/or the troughs between the threads. This type of thread structure is described in detail in U.S. Patent No. 5,902, 109, titled "Reduced Friction, Screw-Type Dental Implant".

[0035] In FIGs. 3a-c, an implant 41 having a wide diameter in the region of the threaded bottom portion 42 is illustrated. The diameter is in the range of from about 4.5 mm to about 6.0 mm with the diameter of 5.0 mm being a fairly common dimension for a wide diameter implant. Such an implant 41 is useful to engage one or both cortical bones to provide enhanced stability, especially during the period of time after installation.

[0036] FIGs. 4a-b illustrate an implant 110 according to another embodiment that may be used with the present invention. The implant 110 includes a middle section 114 designed to extend through the gingiva. Preferably, it is a

smooth surface that includes a titanium nitride coating so the underlying titanium or titanium alloy is not readily seen through the gingiva. The implant 110 also includes a threaded portion 120 that may include various thread structures and is preferably roughened to increase the osseointegration process. It is contemplated that implants
5 other than those illustrated in FIGs. 1-4 may be used with the present invention.

[0037] According to embodiments described herein, a topographically complex implant surface including "layers" of surfaces having distinct and varied scale ranges is disclosed. The topographically complex surface generally includes a submicron roughened surface having tube-like structures superimposed onto one or
10 more micro-scale roughened surface(s) of at least a portion (e.g., the threaded bottom portion) of the surface of an implant. "Micro-scale," as used herein, should be understood to describe an article or feature generally measured in microns such as, for example, 1 micron to 100 microns. "Submicron" or "nanoscale," as used herein, should be understood to describe an article or feature generally measured in
15 nanometers such as, for example, 1 nanometer to 500 nanometers.

[0038] In one embodiment, the implant is a titanium or titanium alloy implant (e.g., from ELI Ti-6Al4V alloy), and the submicron tube-like structures are nanoscale titanium dioxide (TiO₂) tubes formed using potentiostatic anodization using an aqueous solution including fluoride ions. The attributes (e.g., height,
20 diameter, wall thickness, spacing) of the submicron tube-like structures may be directly controlled through the manipulation of the anodization setup and preparation.

[0039] Turning now to FIG. 5, a general method of forming an implant is set forth according to one embodiment. At step 500, an implant is provided. At least a
25 portion of the implant surface is roughened to form a first micro-scale topography at step 501. The roughening of step 501 may include deforming the implant surface, for example, by grit blasting, to form a coarse-micron topography. The coarse-micron topography may include peak-to-valley heights of about 1 micron to about 30 microns. In one embodiment, the coarse-micron topography includes peak-to-
30 valley heights of about 10 microns to about 20 microns. As an example, FIG. 6 shows the implant 10 of FIG. 1 having a roughened surface 630.

[0040] At step 502, the portion of the implant surface is further roughened to form a second micro-scale topography. The second roughening step 502 may include removing/etching at least a portion of the implant surface, for example, by acid etching the implant surface, to form a fine-micron topography. The peak-to-valley heights of the fine-micron topography are generally less than about 10 microns. In one embodiment, the peak-to-valley heights range from about 1 micron to about 3 microns. The peak-to-peak distances may be less than about 3 microns.

[0041] A submicron topography including nanoscale tube-like structures may be superimposed on the first and second micro-scale topographies at step 503. The submicron topography generally includes irregular pockets of nanoscale tube-like structures that are generally consistent in height and diameter. The nanoscale topography may be formed using potentiostatic anodization using an aqueous electrolyte solution including fluoride ions to form the tube-like structures. The heights of the nanoscale tube-like structures may range from about 10 nanometers to several microns. The diameters of the nanoscale tube-like structures may range from about 10 nanometers to about 400 nanometers. In some embodiments, the nanoscale tube-like structures are fabricated from the implant's own TiO₂ layer. The submicron topography of step 503 assists in impacting and accelerating the early stages of osseointegration between the implant surface and adjacent bone.

[0042] The nanoscale tube-like structures are generally formed at the base of the valleys of the second micro-scale topography, leaving the second micro-scale topography generally intact. The available surface at the base of each valley of the second micro-scale topography generally dictates the size of a given cluster of tube-like structures. As such, the tube-like structures form in a generally irregular fashion. This irregularity in cluster formation is further magnified when a given surface includes the coarse-micron and fine-micron features of the first and second micro-scale topographies, respectively.

[0043] Referring now to FIG. 7, a more detailed method of forming an implant according to another embodiment is illustrated. A dental implant comprised of titanium (e.g., chemically pure Grade 3 (chemical) titanium) or a titanium alloy (e.g., titanium 6AL-4V ELI alloy) is provided at step 700. The dental implant may

be a threaded dental implant. The surface of the implant is generally clean and dry. At least a portion of the implant (e.g., the threaded bottom portion for contacting bone) is grit blasted to form a coarse-micron topography at step 701. In one embodiment, a portion of the implant for contacting soft tissue is masked off such that it is not roughened but, rather, remains generally smooth. One non-limiting example of media that may be used to grit blast the surface includes bioresorbable hydroxy apatite (HA) media. The grit blast media may have a grain size of less than about 500 μm in size. In other embodiments, the grain size of the grit blast media used to achieve the desired surface roughness is about 180-300 μm or 300-425 μm . The coarse-micron topography may include peak-to-valley heights of about 1 micron to about 30 microns. In one embodiment, the coarse-micron topography includes peak-to-valley heights of about 10 microns to about 30 microns.

[0044] The threaded bottom portion of the implant is then acid etched to form a fine-micro-scale roughened surface at step 702. The acid etching may include removing a native oxide layer from the implant surface. The native oxide layer may be removed by a first acid solution, which may include aqueous hydrofluoric acid. The threaded bottom portion is then acid etched, which may include immersing the implant in a mixture of sulfuric and hydrochloric acids. This type of roughening method utilized on commercially pure (CP) titanium is described in detail in U.S. Pat. No. 5,876,453, titled "Implant Surface Preparation". An additional roughening method utilized on Titanium 6AL-4V ELI alloy is described in detail in U.S. Pat. App. Pub. No. 2004/0265780, titled "Surface Treatment Process for Implants Made of Titanium Alloy". The peak-to-valley heights of the fine-micro-scale topography are generally less than about 10 microns. In one embodiment, the peak-to-valley heights range from about 1 micron to about 3 microns. The peak-to-peak distances may be less than about 3 microns.

[0045] It is contemplated that other surface roughening techniques may be used to achieve the desired coarse-micron and fine-micron surface topographies described herein. Such roughening techniques may include, but are not limited to, grit blasting, acid etching, titanium plasma spraying, and combinations thereof.

[0046] Grit blasting and acid etching the threaded bottom portion to form the dual-layer micro-scale roughened surface generally results in a surface including both levels of topographies, e.g., with peak-to-valley heights of less than about 10 microns superimposed on a surface having peak-to-valley heights ranging from
5 about 10 microns to about 30 microns.

[0047] At step 703, the dual-layer micro-scale roughened surface is immersed into an aqueous electrolyte solution including fluoride ions and is exposed to potentiostatic anodization to produce a submicron topography including nanoscale tube-like structures superimposed on the dual-layer micro-scale
10 roughened surface. The solution may include, for example, hydrofluoric acid (HF), sodium fluoride (NaF), ammonium fluoride (NH₄F), potassium fluoride (KF), any other compound that can produce sufficient fluoride ions in solution, combinations thereof, or the like. Generally, the potentiostatic anodization described herein results in nanoscale tube-like structures having heights of about 10 nanometers to several
15 microns with diameters ranging from about 10 nanometers to about 400 nanometers. In one embodiment, the nanoscale tube-like structures having heights ranging from about 200 nanometers to about 400 nanometers with diameters ranging from about 75 nanometers to about 125 nanometers.

[0048] For aqueous solutions including fluoride ions, the diameters of the
20 resulting tube-like structures are generally dependent upon the applied system voltage. The heights of the tube-like structures generally depend upon factors such as process time, aqueous solution temperature, aqueous solution content (e.g., high/low H₂O content, fluoride ion source/concentration, etc.), voltage, cathode material (e.g., titanium or Pt-titanium), and the like. Variations in the characteristics
25 of the tube-like structures range from generally flat, honeycomb-like structures to tubes having heights up to several microns.

[0049] In one example, an aqueous electrolyte solution having about 0.125 to about 0.50 w/w% hydrofluoric acid (HF) solution may be prepared using about 49 w/w% HF stock. The solution may be kept at or near room temperature (about 23
30 °C to about 26° C) throughout the anodizing process.

[0050] According to the anodizing process of one embodiment, the positive lead of a 110V power supply is connected to a fixture with a titanium implant secured thereto (anode). The negative lead of the power supply is connected to a titanium or platinum-coated titanium metal plate or mesh structure (cathode). Both the anode and the cathode are secured in a container in close proximity to one another. An electrolytic solution is poured into the container, submerging both the anode and the cathode completely. The power supply may apply a voltage ranging from about 5 volts to about 60 volts with a current of about 1 milliamp to an about 2 amp maximum output. Variations in voltage generally result in variations in the diameters of the resulting tube-like structures. In one embodiment, the power supply is set to about 20V with an about 2 amp maximum output. The power is turned on, and a voltage is applied to the system (anode, cathode, electrolyte solution) for a predetermined time (e.g., about 30 minutes $\pm$ 30 seconds).

[0051] At step 704, the implant is rinsed. The implant may be rinsed any suitable amount of times. In one embodiment, the implant is rinsed in two consecutive reverse osmosis (RO)/deionized water (DI) baths for about 30 seconds each. The RO/DI baths may have temperatures ranging from about 23° C to about 26° C. The RO/DI baths represent a room temperature, drag-out rinse and a final rinse, respectively, used to remove residual solution from processing (step 703). The implant may then be rinsed in a heated RO/DI bath having a temperature ranging from about 60° C to about 70° C for about 30 seconds to facilitate flash drying.

[0052] At step 705, the implant may be oven dried to further facilitate flash drying of the implant. In one embodiment, the implant is placed into a forced convection oven directly following the rinse(s) of step 704. The implant may be allowed to dry in the oven for about 20 minutes to about 40 minutes. In one embodiment, the implant is dried at a temperature of about 100° C for about 30 minutes.

[0053] At step 706, the implant is annealed in a high temperature furnace at a temperature ranging from about 475° C to about 550° C for about 115 minutes to about 125 minutes. In one embodiment, the implant is annealed at a temperature of about 525° C for about 2 hours.

[0054] Hydroxyapatite (HA) nanocrystals may then optionally be deposited over and throughout the complexities of the submicron tube-like structures of the implant at step 707, thereby creating a fourth layer of topographical complexity. The HA nanocrystals may have a size ranging from about 1 nanometer to about 100
5 nanometers. In one embodiment, the size of the HA nanocrystals ranges from about 5 nanometers to about 20 nanometers. The HA nanocrystals may be applied as discrete nanocrystals, such that a portion(s) of the surface of the implant for contacting bone is exposed. The increase in topographical complexity - from the addition of both the submicron tube-like structures and the HA nanocrystals - further
10 enhances the early stages of osseointegration.

[0055] The HA nanocrystals may be introduced onto the nanoscale roughened surface of the implant by immersing the implant in a solution including the HA nanoparticles. In one embodiment, the solution including the HA nanoparticles is in the form of a colloid. A representative amount of HA in the
15 colloid is typically in the range of about 0.01 weight percent to about 1 weight percent (e.g., 0.10 weight percent). To form the colloid, HA nanocrystals may be combined in solution with a 2-methoxyethanol solvent and ultrasonically dispersed and de-agglomerated. The pH of the colloidal solution may be adjusted with sodium hydroxide, ammonium hydroxide, or the like to a pH of about 7 to about 13. As
20 such, the colloidal solution may include HA nanocrystals, 2-methoxyethanol, and a pH adjuster (e.g. ammonium hydroxide, and/or sodium hydroxide). This type of HA deposition is described in detail in U.S. Patent Application Publication Nos. 2007/0110890 and 2007/0112353, both titled "Deposition of Discrete Nanoparticles on an Implant Surface".

[0056] The implant may then be rinsed in RO/DI water to remove residual solvent and HA at step 709. The implant may be rinsed any suitable amount of times. In one embodiment, the implant is rinsed in two consecutive RO/DI baths for about 30 seconds each. The RO/DI baths may have temperatures ranging from about 23° C to about 27° C. In one embodiment, the temperature of the rinse baths is about 25°
30 C. The implant may then be rinsed in a heated RO/DI bath having a

temperature ranging from about 60° C to about 70° C for about 28 to about 32 seconds.

[0057] The implant may then be dried (e.g., oven dried) to facilitate flash drying of the implant at step 714. The implant may be dried for about 20 to about 40 minutes at a temperature of about 90° C to about 110° C. In one embodiment, the implant is placed in a forced-convection oven directly following the rinse(s) of step 709 and dried at a temperature of about 100° C for about 30 minutes. The implant is optionally sterilized at step 716 using, for example, gamma sterilization.

[0058] Alternatively or in addition to the acts of depositing HA nanocrystals at step 707, sodium lactate or another non-toxic salt(s) may be applied over and throughout the complexities of the submicron tube-like structures and/or over the HA nanoparticles of the implant at step 708. The sodium lactate or other non-toxic salt(s) may assist in increasing the hydrophilicity of the implant surface, thereby enhancing osseointegration.

[0059] The implant surface may be characterized utilizing Field Emission Scanning Electron microscopy (FESEM). Depending upon the resolution of the instrument, the tube-like structures may typically be witnessed at magnifications of 10kX or higher.

Example 1

[0060] FIGs. 8a, 8b, and 8c are FESEM images showing surface complexities having a coarse-micron topography (the outer borders of which are indicated by numeral 80), a fine-micron topography 82, and a submicron topography comprising nanoscale tube-like structures 84 on a commercially pure titanium implant. The image of FIG. 8a was taken at 5kX utilizing an FESEM. The image of FIG. 8b was taken at 10kX utilizing an FESEM. The image of FIG. 8c was taken at 30kX utilizing an FESEM.

[0061] The surfaces of FIGs. 8a, 8b, and 8c were formed by first grit blasting a commercially pure titanium surface with a bioresorbable hydroxyapatite (HA) media. The HA media was generally below about 500µm in grain size. The HA media was shot at the implant surface using pressurized air in an automated blasting machine. The grit-blasted implant was then cleaned in a heated (about 50-

70 °C), about 25 v/v% nitric acid (HNO₃) solution for about 5 minutes (±15 seconds) using ultrasonics. The implant was then immersed in three consecutive ambient (about 20-26 °C) RO/DI H₂O baths for about 30 seconds (±2 seconds) each to facilitate the removal of residual acid. The implant was then dried using a forced-hot air convection oven at about 100 °C (±10 °C) for about 30 minutes (±10 minutes).

[0062] The resulting implant was then acid etched by immersing the implants in an ambient (about 20-26 °C), about 7.5 v/v% hydrofluoric acid (HF) solution for about 15 seconds (±2 seconds). The HF reacted with and removed the native titanium dioxide layer from the implant surface. The implant was then immersed in three consecutive ambient (about 20-26 °C) RO/DI H₂O baths for about 2-4 seconds each to facilitate the removal of residual acid. The implant was then immersed in a heated (about 60-70 °C), sulfuric/hydrochloric acid (H₂SO₄/HCl) solution for about 7 minutes (±10 seconds). The acid reacted with the titanium surface and created a micron roughened topography having peak-to-peak pits ranging from about 1 μm to about 3 μm. The implant was then immersed in three consecutive ambient (about 20-26 °C) RO/DI H₂O baths for about 30 seconds (±2 seconds) each to facilitate the removal of residual acid. The implant was then dried using a forced-hot air convection oven at about 100 °C (± 10 °C) for about 30 minutes (±10 minutes).

[0063] The nanoscale tube-like structures of FIGs. 8a-8c were formed using potentiostatic anodization, as discussed above, applying a voltage of about 30 volts ± 0.2 volts. The nanoscale tube-like structures were found to have heights ranging from about 200 to about 400 nanometer height and diameters ranging from about 75 to about 125 nanometers.

[0064] It is contemplated that various combinations of variables (e.g., applied system voltage, process time, aqueous solution content, and the like) may be used to form the desired surface attributes.

[0065] Implants formed using the methods described herein were found to have many advantages. For example, the topographically complex surface features described herein, having undercuts at specific and varied scale ranges (i.e., coarse-

- micron, fine-micron, and submicron), can drastically and independently influence various stages of osseointegration. Namely, osseointegration of the implants with the adjacent bone was accelerated through the increase in osteoconductive activity of early bone healing such as protein absorption, blood clot formation and retention,
- 5 osteoblast recruitment (e.g., increased cell migration, proliferation), and bone bonding ability. An implant having a combination of coarse-micron, fine-micron, and submicron topographically complex surface features superimposed on one another has been shown to outperform (e.g., in mechanical disruption force testing) other implants having lesser surface complexity in both early and later time points.
- 10 For example, the micron-scale roughness on at least the portion of the implant that contacts hard tissue (e.g., bone) provides increased osseointegration strength, which is accelerated by the submicron tube-like structures. Successful and prolonged implant integration favors and is dependent upon topographical complexity at distinct scale ranges.
- 15 **[0066]** Additionally, the implants described herein do not require any additional material to be applied thereto. Rather, the underlying micron and submicron topographies are created from the substrate (e.g., titanium) itself. As such, foreign materials do not need to be deposited onto the surface of the implant. This results in a generally more consistent topography, without, for example, the
- 20 need to process and control complex stock solutions or verify (and re-verify) solution parameters (e.g., pH, particle size analysis (PSA), concentration) for production use. Implants formed using the methods described herein are also generally less expensive to produce than those requiring additional material(s) to be deposited thereon.
- 25 **[0067]** While the present invention has been generally described relative to the part of the implant contacting bone tissue, it is contemplated that the acts of grit blasting, acid etching, roughening, creating nanoscale tube-like structures, and depositing herein described may be performed on the entire implant.
- [0068]** While the present invention has been described with reference to one
- 30 or more particular embodiments, those skilled in the art will recognize that many changes may be made thereto without departing from the spirit and scope of the

present invention. Each of these embodiments and obvious variations thereof is contemplated as falling within the spirit and scope of the claimed invention, which is set forth in the following claims.

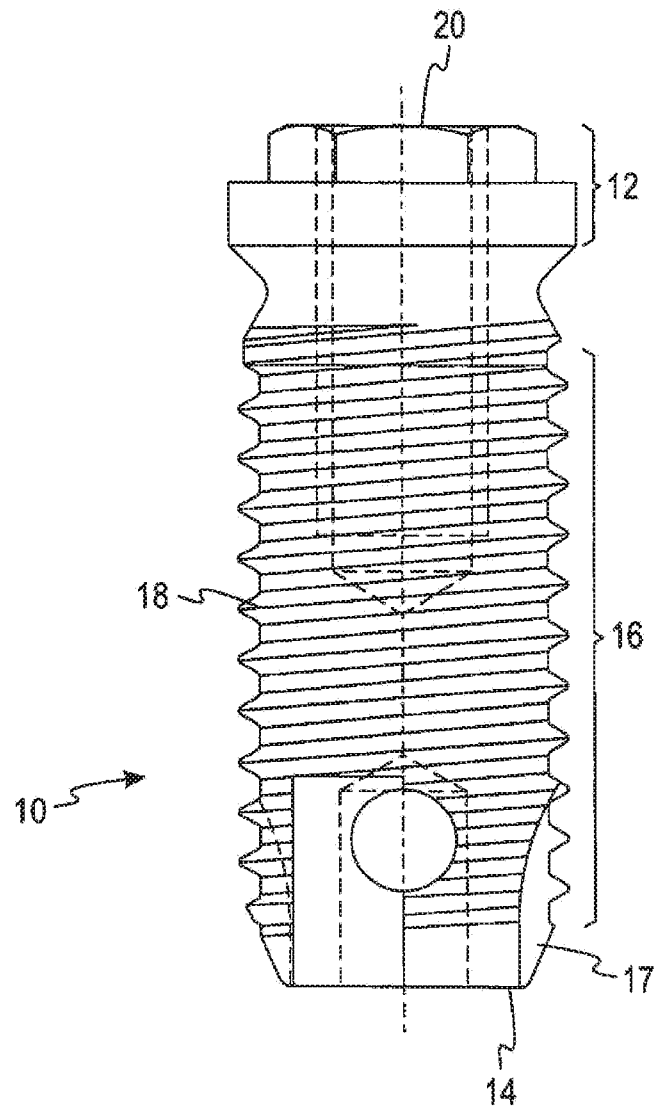
WHAT IS CLAIMED IS:

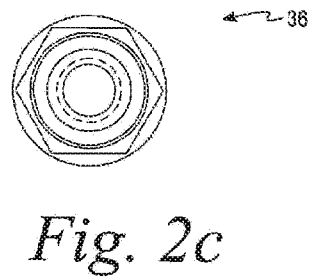
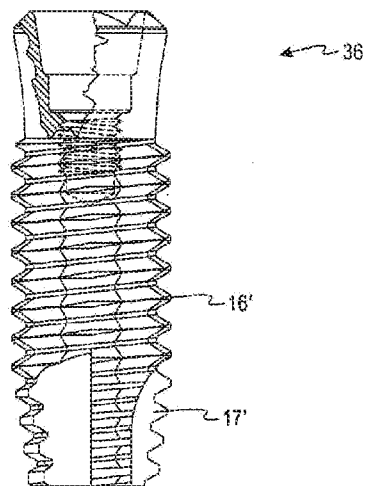
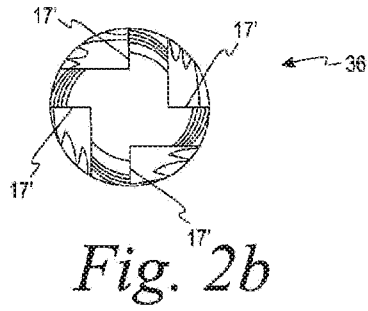
1. A method of forming an implant to be implanted into living bone, the implant being formed of a material comprising titanium, the method comprising the acts of:
 - 5 deforming at least a portion of a surface of the implant to produce a first micro-scale topography;
 - removing at least a portion of the surface to produce a second micro-scale topography superimposed on the first topography, the second micro-scale topography being generally less coarse than the first micro-scale topography; and
 - 10 adding a submicron topography superimposed on the first and second micro-scale topographies, the submicron topography including tube-like structures.
2. The method of claim 1, wherein the act of deforming the implant surface to produce the first micro-scale topography comprises grit blasting the surface.
- 15 3. The method of claim 2, wherein the first micro-scale topography includes peak-to-valley heights of about 1 μm to about 30 μm .
4. The method of any one of claims 1 and 2, wherein the act of removing the
 - 20 implant surface to produce the second micro-scale topography comprises:
 - removing a native oxide layer from the implant surface; and
 - acid etching the resulting surface.
5. The method of claim 4, wherein the act of acid etching the surface includes
 - 25 using a solution including sulfuric acid and hydrochloric acid.
6. The method of claim 5, wherein the second micro-scale topography includes peak-to-valley heights of less than about 10 microns and peak-to-peak distances of less than about 3 microns.

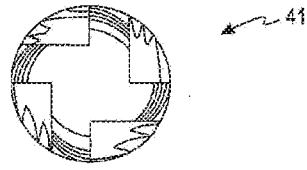
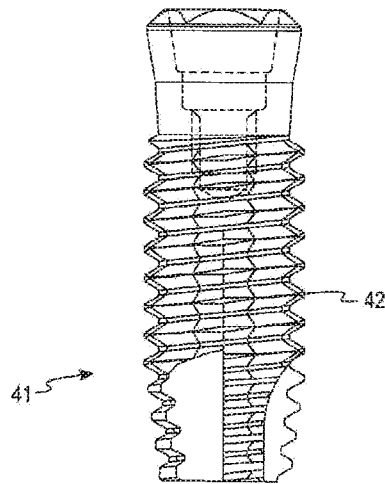
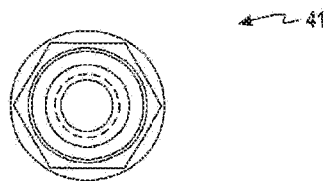
30

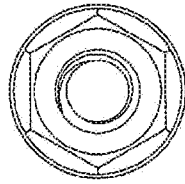
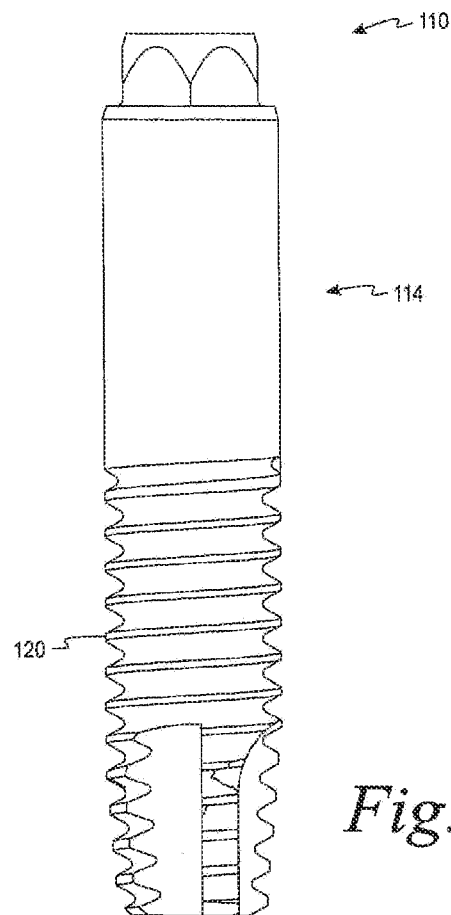
7. The method of any one of claims 1 through 6, wherein the tube-like structures are formed from titanium dioxide.
8. The method of claim 7, wherein the act of adding the submicron topography includes potentiostatic anodization.
9. The method of any one of claims 1 through 8, further comprising depositing discrete nanoparticles on the first micro-scale topography, the second micro-scale topography, and the submicron topography.
10. The method of any one of claims 1 through 9, wherein the tube-like structures have heights in the range of about 200 nanometers to about 400 nanometers.
11. An implant to be implanted into living bone, the implant being formed of a material comprising titanium, the implant comprising:
a first micro-scale topography;
a second micro-scale topography superimposed on the first topography, the second micro-scale topography being generally less coarse than the first micro-scale topography; and
a submicron topography superimposed on the first and second micro-scale topographies, the submicron topography including tube-like structures.
12. The implant of claim 11, wherein the first micro-scale topography includes peak-to-valley heights of about 1 μm to about 30 μm .
13. The implant of any one of claims 11 and 12, wherein the second micro-scale topography includes peak-to-valley heights of less than about 10 microns and peak-to-peak distances of less than about 3 microns.

14. The implant of any one of claims 11 through 13, wherein the tube-like structures are formed from titanium dioxide.
15. The implant of any one of claims 11 through 14, further comprising discrete
5 nanoparticles deposited on the first micro-scale topography, the second micro-scale topography, and the submicron topography.

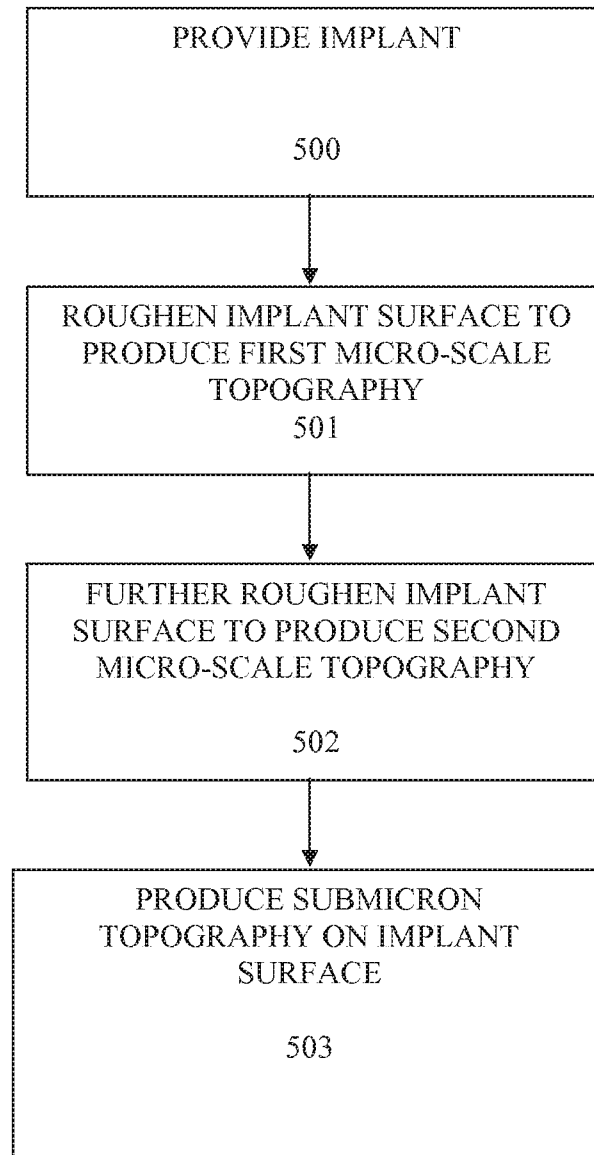
*Fig. 1*



*Fig. 3b**Fig. 3a**Fig. 3c*

*Fig. 4b**Fig. 4a*

5/9

Fig. 5

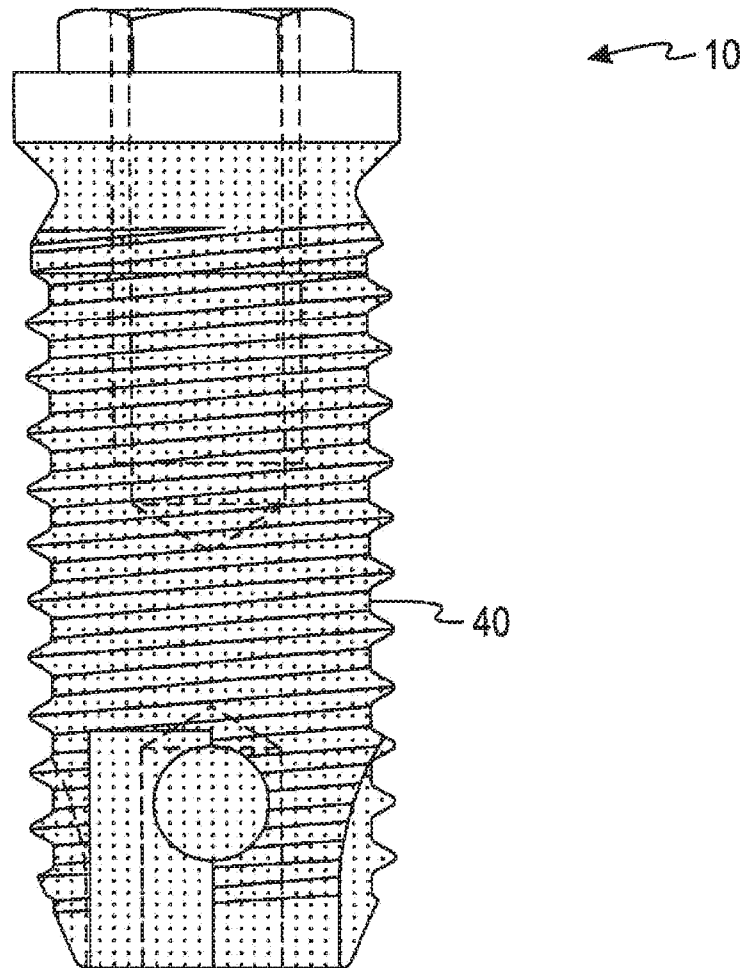


Fig. 6

7/9

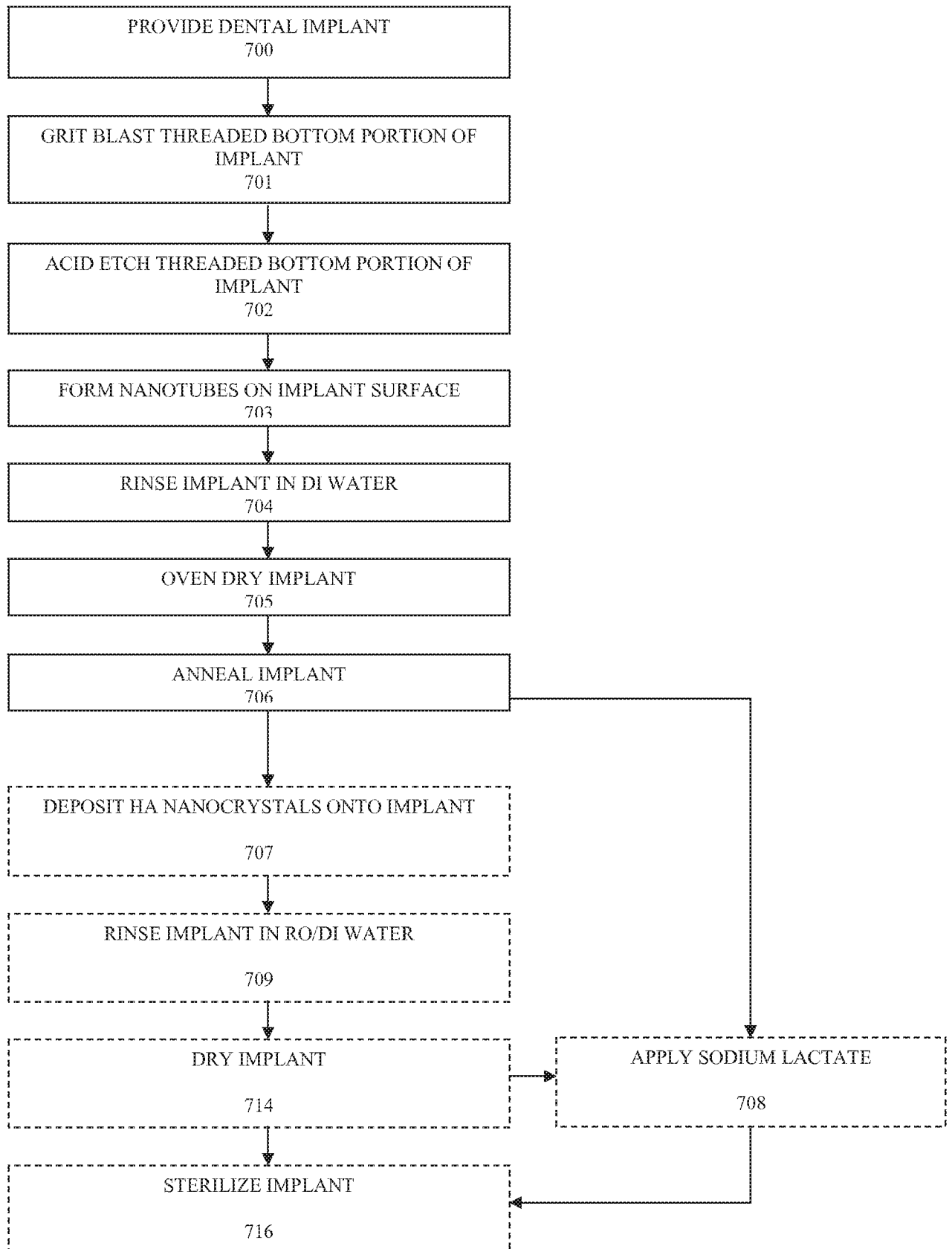
Fig. 7

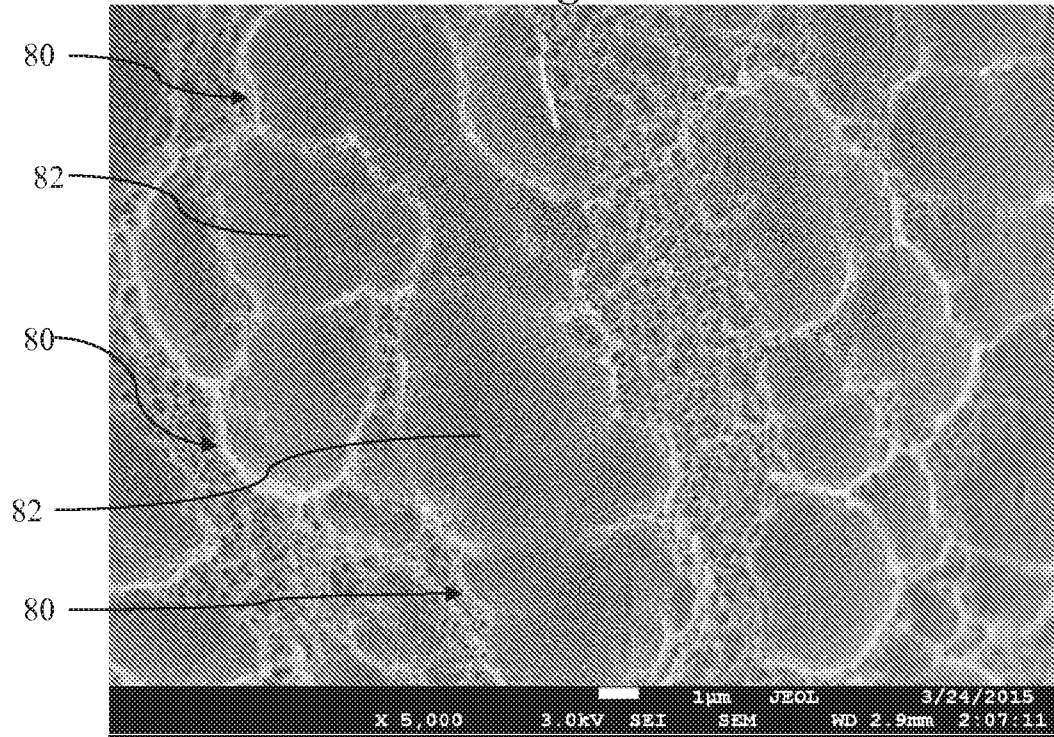
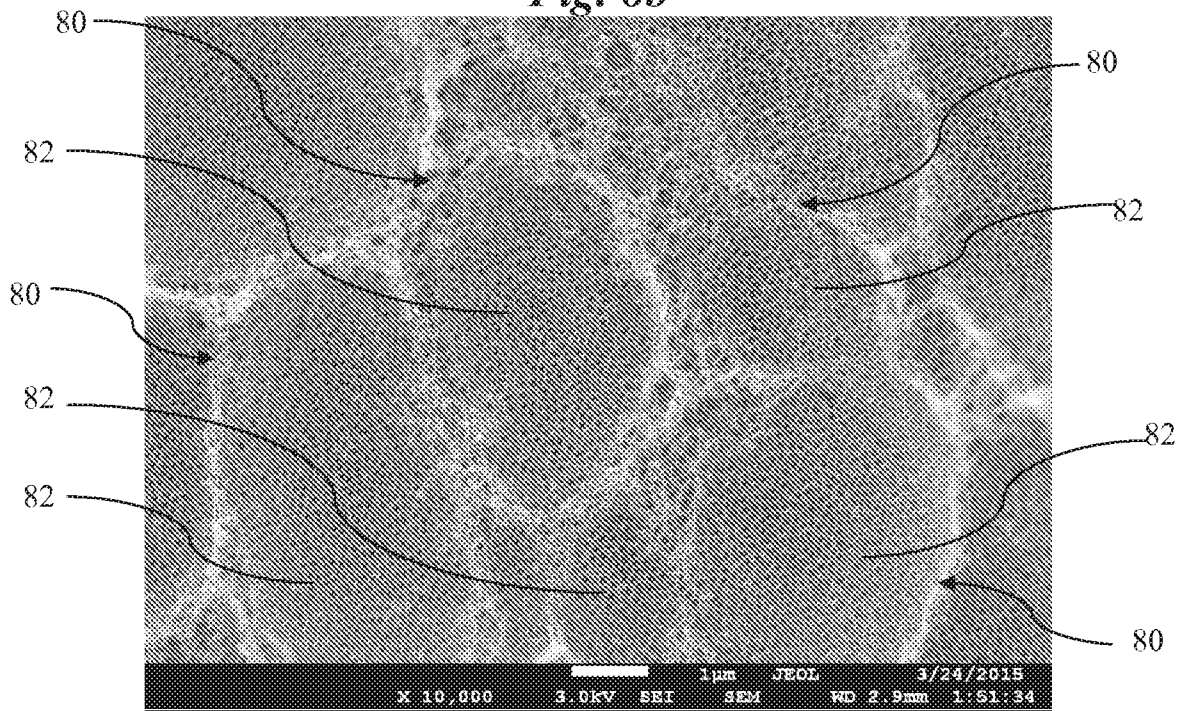
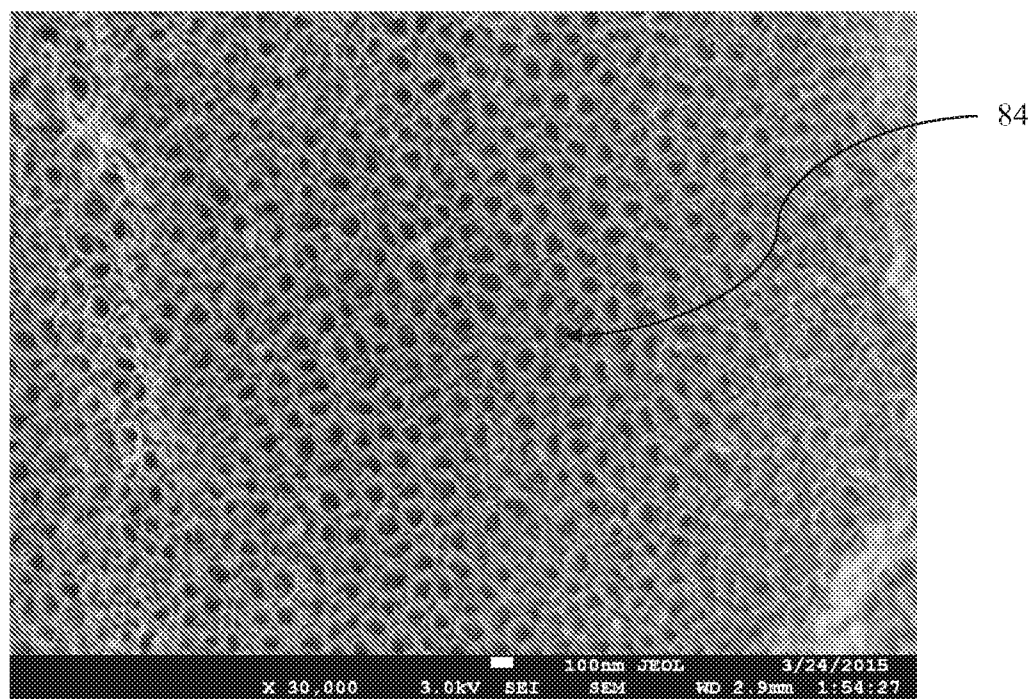
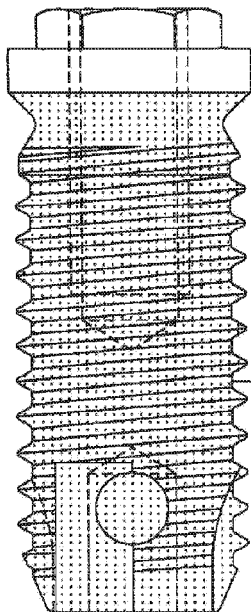
Fig. 8a*Fig. 8b*

Fig. 8c



← 10

40